

# **MOSFET**

### OptiMOS<sup>™</sup> 5 Power-Transistor, 80 V

#### **Features**

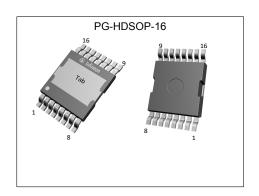
- N-channel
- Very low on-resistance R<sub>DS(on)</sub>
   Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

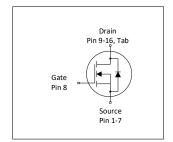
#### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

| Parameter                | Value | Unit |
|--------------------------|-------|------|
| <b>V</b> <sub>DS</sub>   | 80    | V    |
| $R_{	extsf{DS(on),max}}$ | 1.1   | mΩ   |
| I <sub>D</sub>           | 408   | A    |
| Qoss                     | 207   | nC   |
| Q <sub>G</sub>           | 178   | nC   |











| Type / Ordering Code | Package     | Marking  | Related Links |
|----------------------|-------------|----------|---------------|
| IPTC011N08NM5        | PG-HDSOP-16 | 11N08NM5 | -             |

# OptiMOS<sup>™</sup> 5 Power-Transistor, 80 V



# **Table of Contents**

| Description                         | 1 |
|-------------------------------------|---|
| Maximum ratings                     | 3 |
| Thermal characteristics             | 3 |
| Electrical characteristics          | 4 |
| Electrical characteristics diagrams | 6 |
| Package Outlines                    | 0 |
| Revision History                    | 3 |
| Trademarks 1                        | 3 |
| Disclaimer                          | 3 |

# OptiMOS<sup>™</sup> 5 Power-Transistor, 80 V IPTC011N08NM5



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

| Davamatar                                    | Ols a l                  |                  | Value       | S                       |      |   |
|--|--------------------------|------------------|-------------|-------------------------|------|---|
| Parameter                                    | Symbol                   | Min.             | Тур.        | Max.                    | Unit | Note / Test Condition   |
| Continuous drain current <sup>1)</sup>       | I <sub>D</sub>           | -<br>-<br>-<br>- | -<br>-<br>- | 408<br>295<br>237<br>42 | A    | $V_{GS}$ =10 V, $T_{C}$ =25 °C<br>$V_{GS}$ =10 V, $T_{C}$ =100 °C<br>$V_{GS}$ =6 V, $T_{C}$ =100 °C<br>$V_{GS}$ =10V, $T_{A}$ =25°C, $R_{thJA}$ =40°C/W <sup>2)</sup> |
| Pulsed drain current <sup>3)</sup>           | I <sub>D,pulse</sub>     | -                | -           | 1632                    | Α    | <i>T</i> <sub>A</sub> =25 °C  |
| Avalanche energy, single pulse <sup>4)</sup> | <b>E</b> AS              | -                | -           | 817                     | mJ   | $I_D$ =150 A, $R_{GS}$ =25 Ω  |
| Gate source voltage                          | V <sub>GS</sub>          | -20              | -           | 20                      | V    | -   |
| Power dissipation                            | P <sub>tot</sub>         | -                | -           | 375<br>3.8              | W    | T <sub>C</sub> =25 °C<br>T <sub>A</sub> =25 °C, R <sub>thJA</sub> =40 °C/W <sup>2)</sup>  |
| Operating and storage temperature            | $T_{\rm j},~T_{\rm stg}$ | -55              | -           | 175                     | °C   | IEC climatic category; DIN IEC 68-1 55/175/56   |

#### 2 Thermal characteristics

Table 3 **Thermal characteristics** 

| Parameter  | Symbol            | Values |      |      | Unit  | Note / Test Condition |
|--|-------------------|--------|------|------|-------|-----------------------|
| Farameter  | Symbol            | Min.   | Тур. | Max. | Ollit | Note / Test Condition |
| Thermal resistance, junction - case                          | R <sub>thJC</sub> | -      | 0.2  | 0.4  | °C/W  | -                     |
| Thermal resistance, junction - ambient, 6 cm² cooling area²) |                   | -      | -    | 40   | °C/W  | -                     |
| Thermal resistance, junction - ambient, minimal footprint    | R <sub>thJA</sub> | -      | -    | 62   | °C/W  | -                     |

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

# OptiMOS<sup>™</sup> 5 Power-Transistor, 80 V IPTC011N08NM5



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

| Banana dan                       | 0                    | Values |            |            |      |   |
|----------------------------------|----------------------|--------|------------|------------|------|---|
| Parameter                        | Symbol               | Min.   | Тур.       | Max.       | Unit | Note / Test Condition   |
| Drain-source breakdown voltage   | V <sub>(BR)DSS</sub> | 80     | -          | -          | V    | V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA  |
| Gate threshold voltage           | V <sub>GS(th)</sub>  | 2.2    | 3.0        | 3.8        | V    | $V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 280 \ \mu {\rm A}$  |
| Zero gate voltage drain current  | I <sub>DSS</sub>     | -      | 0.1<br>10  | 1.0<br>100 | μA   | V <sub>DS</sub> =80 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C<br>V <sub>DS</sub> =80 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C |
| Gate-source leakage current      | $I_{\mathrm{GSS}}$   | -      | 10         | 100        | nA   | V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V   |
| Drain-source on-state resistance | R <sub>DS(on)</sub>  | -      | 1.0<br>1.3 | 1.1<br>1.7 | mΩ   | V <sub>GS</sub> =10 V, I <sub>D</sub> =150 A<br>V <sub>GS</sub> =6 V, I <sub>D</sub> =75 A  |
| Gate resistance <sup>1)</sup>    | R <sub>G</sub>       | -      | 1.6        | 2.4        | Ω    | -   |
| Transconductance                 | <b>g</b> fs          | 120    | 270        | -          | S    | $ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 100 A$   |

Table 5 **Dynamic characteristics** 

| Development                                | Cross bod          | Values |       |       | 11   | Nata / Tank Oans IIII an  |
|--|--------------------|--------|-------|-------|------|---|
| Parameter                                  | Symbol             | Min.   | Тур.  | Max.  | Unit | Note / Test Condition   |
| Input capacitance <sup>1)</sup>            | C <sub>iss</sub>   | -      | 13000 | 17000 | pF   | V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, f=1 MHz                                      |
| Output capacitance <sup>1)</sup>           | Coss               | -      | 2000  | 2600  | pF   | V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, f=1 MHz                                      |
| Reverse transfer capacitance <sup>1)</sup> | C <sub>rss</sub>   | -      | 86    | 150   | pF   | V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, f=1 MHz                                      |
| Turn-on delay time                         | t <sub>d(on)</sub> | -      | 35    | -     | ns   | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 $\Omega$ |
| Rise time                                  | t <sub>r</sub>     | -      | 31    | -     | ns   | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 $\Omega$ |
| Turn-off delay time                        | $t_{ m d(off)}$    | -      | 82    | -     | ns   | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 $\Omega$ |
| Fall time                                  | t <sub>f</sub>     | -      | 30    | -     | ns   | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 $\Omega$ |

Gate charge characteristics<sup>2)</sup> Table 6

| Parameter                          | Cumbal               | Values |      |      | 11:4 | Note / Test Condition  |
|------------------------------------|----------------------|--------|------|------|------|--|
| Parameter                          | Symbol               | Min.   | Тур. | Max. | Unit | Note / Test Condition  |
| Gate to source charge              | Q <sub>gs</sub>      | -      | 55   | -    | nC   | $V_{DD}$ =40 V, $I_{D}$ =100 A, $V_{GS}$ =0 to 10 V                      |
| Gate charge at threshold           | $Q_{g(th)}$          | -      | 37   | -    | nC   | $V_{DD}$ =40 V, $I_{D}$ =100 A, $V_{GS}$ =0 to 10 V                      |
| Gate to drain charge <sup>1)</sup> | $Q_{gd}$             | -      | 37   | 56   | nC   | V <sub>DD</sub> =40 V, I <sub>D</sub> =100 A, V <sub>GS</sub> =0 to 10 V |
| Switching charge                   | Q <sub>sw</sub>      | -      | 55   | -    | nC   | $V_{DD}$ =40 V, $I_{D}$ =100 A, $V_{GS}$ =0 to 10 V                      |
| Gate charge total <sup>1)</sup>    | <b>Q</b> g           | -      | 178  | 223  | nC   | $V_{DD}$ =40 V, $I_{D}$ =100 A, $V_{GS}$ =0 to 10 V                      |
| Gate plateau voltage               | V <sub>plateau</sub> | -      | 4.4  | -    | V    | $V_{DD}$ =40 V, $I_{D}$ =100 A, $V_{GS}$ =0 to 10 V                      |
| Output charge <sup>1)</sup>        | Qoss                 | -      | 207  | 275  | nC   | V <sub>DS</sub> =40 V, V <sub>GS</sub> =0 V                              |

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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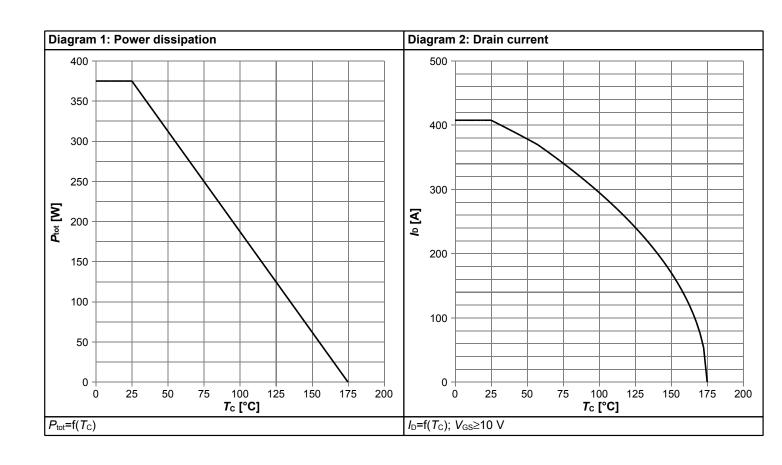


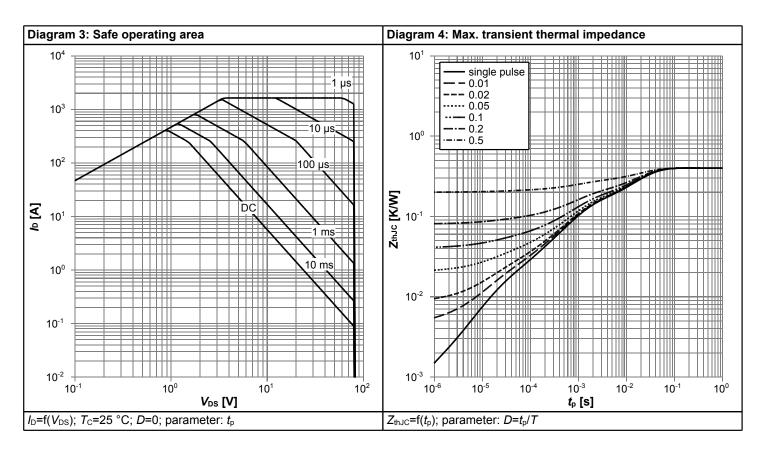
#### Table 7 Reverse diode

| Danamatan                             | Cumbal               |      | Values |      |      | Nata / Tank Oam dition  |  |
|---------------------------------------|----------------------|------|--------|------|------|---|--|
| Parameter                             | Symbol               | Min. | Тур.   | Max. | Unit | Note / Test Condition   |  |
| Diode continuous forward current      | I <sub>S</sub>       | -    | -      | 320  | Α    | <i>T</i> <sub>C</sub> =25 °C  |  |
| Diode pulse current                   | I <sub>S,pulse</sub> | -    | -      | 1632 | Α    | <i>T</i> <sub>C</sub> =25 °C  |  |
| Diode forward voltage                 | V <sub>SD</sub>      | -    | 0.88   | 1.0  | V    | V <sub>GS</sub> =0 V, I <sub>F</sub> =150 A, T <sub>j</sub> =25 °C        |  |
| Reverse recovery time <sup>1)</sup>   | t <sub>rr</sub>      | -    | 106    | 212  | ns   | $V_R$ =40 V, $I_F$ =100 A, $dI_F/dt$ =100 A/ $\mu$ s                      |  |
| Reverse recovery charge <sup>1)</sup> | Qrr                  | -    | 318    | 636  | nC   | V <sub>R</sub> =40 V, I <sub>F</sub> =100 A, di <sub>F</sub> /dt=100 A/μs |  |

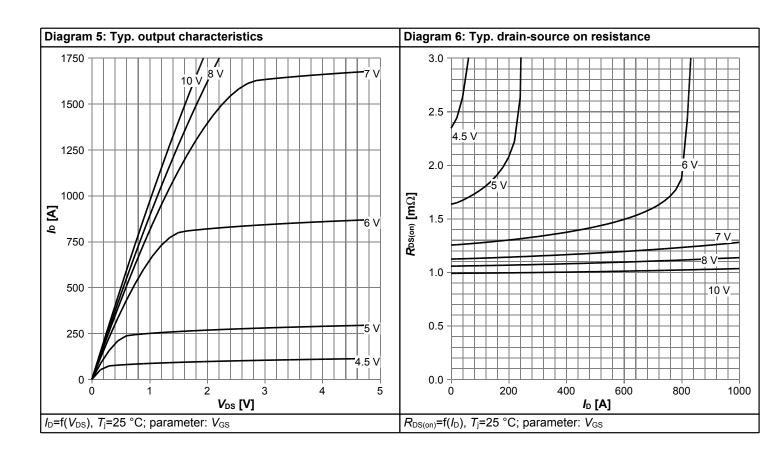


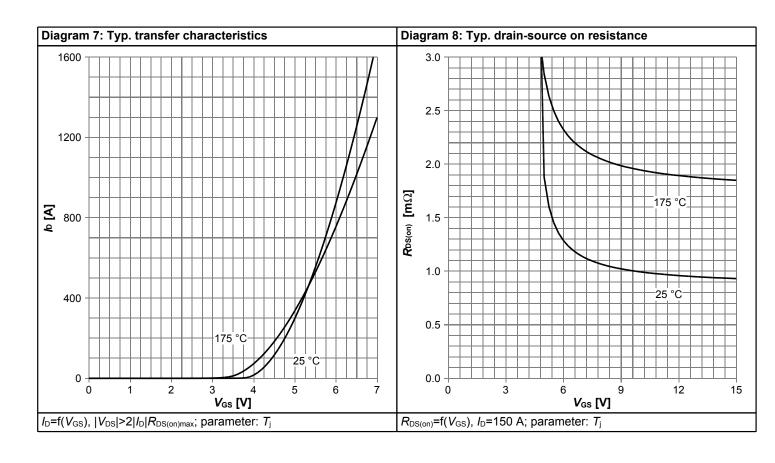
# 4 Electrical characteristics diagrams



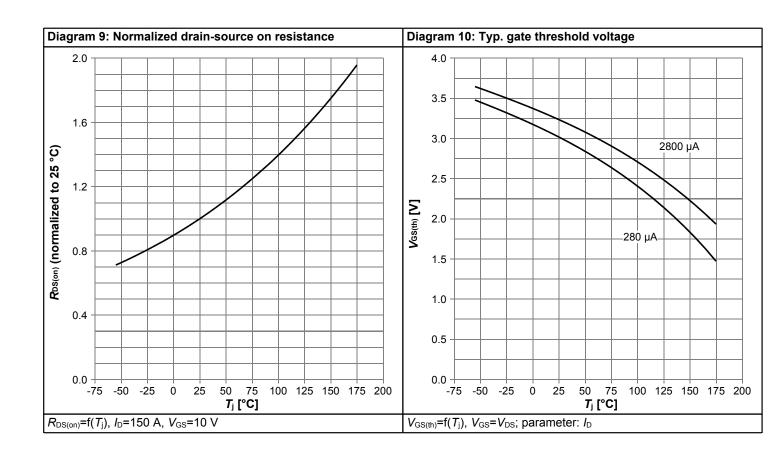


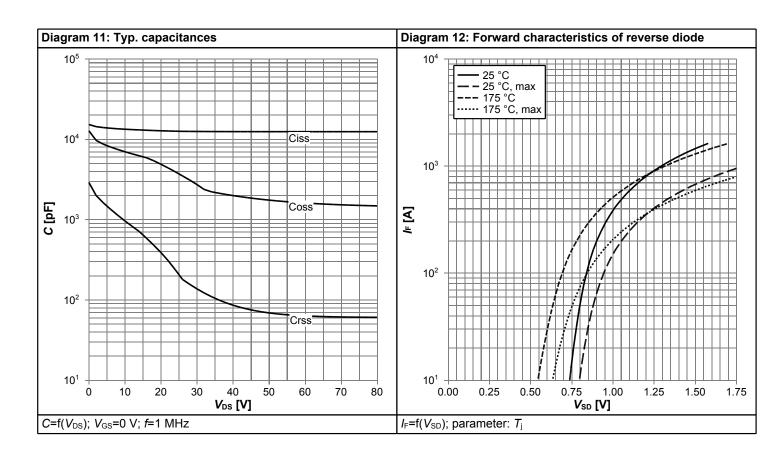




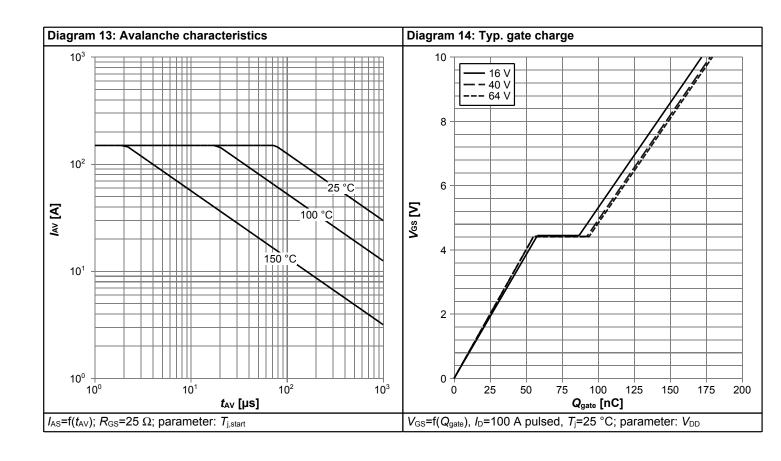


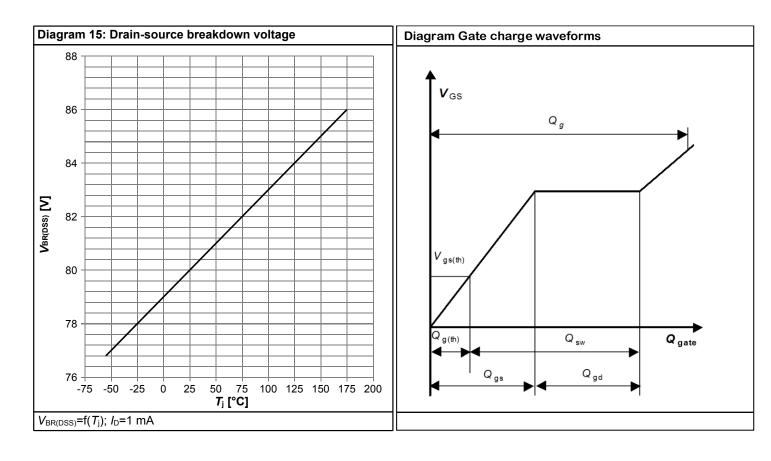






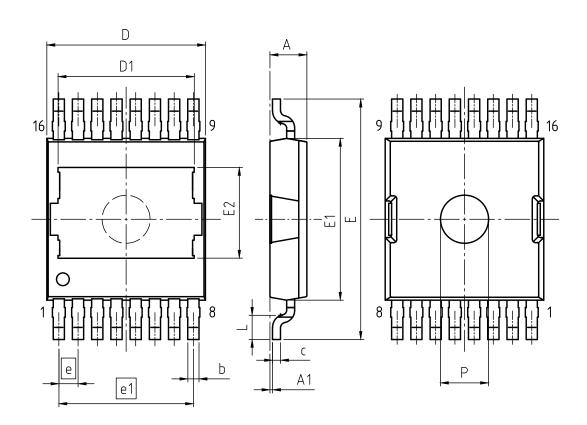








# 5 Package Outlines



| PACKAGE - GROUP<br>NUMBER: | PG-HDSC | PG-HDSOP-16-U01 |  |  |  |  |
|----------------------------|---------|-----------------|--|--|--|--|
| REVISION: 01               | DATE:   | 18.12.2020      |  |  |  |  |
| DIMENSIONS                 | MILLIM  | ETERS           |  |  |  |  |
| DIMENSIONS                 | MIN.    | MAX.            |  |  |  |  |
| Α                          | 2.25    | 2.35            |  |  |  |  |
| A1                         | 0.01    | 0.16            |  |  |  |  |
| b                          | 0.60    | 0.80            |  |  |  |  |
| С                          | 0.40    | 0.60            |  |  |  |  |
| D                          | 9.70    | 10.10           |  |  |  |  |
| D1                         | 8.20    | 8.40            |  |  |  |  |
| E                          | 14.80   | 15.20           |  |  |  |  |
| E1                         | 10.00   | 10.30           |  |  |  |  |
| E2                         | 5.57    | 5.77            |  |  |  |  |
| е                          | 1.20    |                 |  |  |  |  |
| e1                         | 8.40    |                 |  |  |  |  |
| L                          | 1.40    | 1.60            |  |  |  |  |
| P                          | 2.90    | 3.10            |  |  |  |  |

Figure 1 Outline PG-HDSOP-16, dimensions in mm



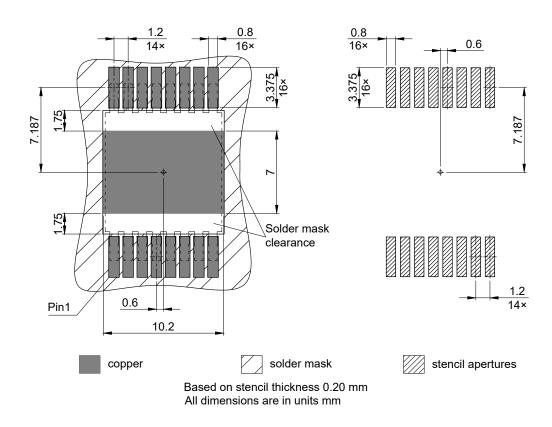
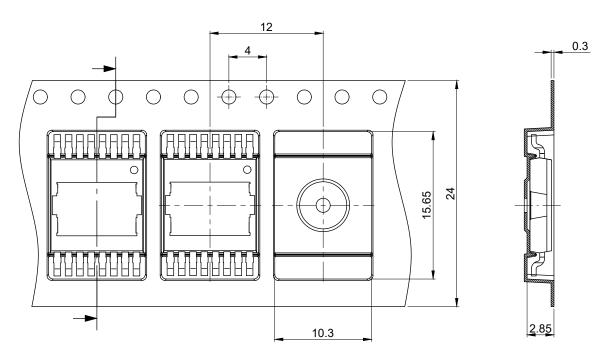


Figure 2 Outline Footprint (PG-HDSOP-16), dimensions in mm





All dimensions are in units mm

The drawing is in compliance with ISO 128-30, Projection Method 1 [

Figure 3 Outline Tape (PG-HDSOP-16), dimensions in mm

### OptiMOS<sup>TM</sup> 5 Power-Transistor, 80 V IPTC011N08NM5



#### **Revision History**

IPTC011N08NM5

Revision: 2022-05-24, Rev. 2.0

Previous Revision

| Revision | Date       | Subjects (major changes since last revision) |  |  |  |  |
|----------|------------|--|--|--|--|--|
| 2.0      | 2022-05-24 | Release of final version                     |  |  |  |  |

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